ETR05051-004a

### HiSAT-COT<sub>®</sub> Control, 6.0A Synchronous Step-Down DC/DC Converters

#### ☆Green Operation-compatible

### ■GENERAL DESCRIPTION

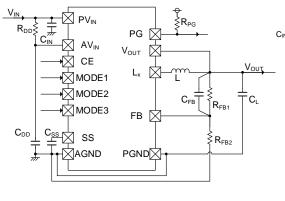
The XC9266 series is a group of synchronous-rectification type DC/DC converters with a built-in  $32m\Omega$  P-channel MOS driver transistor and  $25m\Omega$  N-channel MOS switching transistor, designed to allow the use of ceramic capacitors. The small on-resistances of these two internal driver transistors enable a high efficiency, stable power supply with an output current up to 6.0A. A 0.6V reference voltage source is incorporated, and the output voltage can be set freely by external resistors. Oscillation frequency is set to 1.2MHz or 3.0MHz can be selected for suiting to your particular application. The operation mode is HiSAT-COT<sub>®</sub> Control (\*) control, which has an excellent transient response. PWM control or PWM/PFM auto switching control can be selected at the MODE1 pin, and a high-speed response, low ripple, and high efficiency are achieved across the entire load range (from light loads to heavy loads). As for the soft-start function as fast as 0.25ms in typical for quick turn-on. The soft start time can be set as desired by adding an external capacitance to the SS pin. Internal protection circuits include over current protection, short-circuit protection, and thermal shutdown circuits to enable safe use. Short circuit protection or Hiccup mode can be selected at the MODE2 pin.

Soft-off function and  $C_L$  High Speed discharge function discharge the electric charge at the output capacitor  $C_L$  when putting the IC in a stand-by mode. Soft-off function can be selected at the MODE3 pin. The package is the QFN0404-24C (4mm × 4mm).

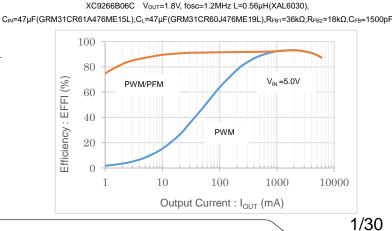
<sup>(1)</sup>HiSAT-COT is a proprietary high-speed transient response technology for DC/DC converter which was developed by Torex. It is Ideal for the LSI's that require high precision and high stability power supply voltage

| ■ APPLICATIONS<br>● PC                             | FEATURES                      | : | 2.7V ~ 5.5V                                                                |
|----------------------------------------------------|-------------------------------|---|----------------------------------------------------------------------------|
| <ul> <li>Graphic board</li> <li>Storage</li> </ul> | Output Voltage Range          | : | PWM control 0.6V ~ 3.6V<br>PWM/PFM automatic switching control 0.8V ~ 3.6V |
| Industrial application                             | FB Voltage                    | : | $0.6V \pm 1.0\%$                                                           |
| FPGA                                               | Output Current                | : | 6.0A                                                                       |
| • SSD                                              | Oscillation Frequency         | : | 1.2MHz, 3.0MHz                                                             |
| • ASIC                                             | Efficiency                    | : | 93%(VIN=5.0V, VOUT=1.8V, IOUT=1.0A)                                        |
| DSP                                                | Control Methods               | : | HiSAT-COT <sub>®</sub> Control                                             |
|                                                    |                               |   | 100% Duty Cycle                                                            |
|                                                    |                               |   | Mode select between                                                        |
|                                                    |                               |   | Fixed PWM and PWM/PFM Auto                                                 |
|                                                    | Protection Circuits           | : | Thermal Shutdown                                                           |
|                                                    |                               |   | Current Limit (Pendent character)                                          |
|                                                    |                               |   | HICCUP or Short Circuit Protection                                         |
|                                                    | Functions                     | : | UVLO, Soft-Start, Soft-off                                                 |
|                                                    |                               |   | C∟ High Speed Discharge ,Power good                                        |
|                                                    | Output Capacitor              | : | Ceramic Capacitor                                                          |
|                                                    | Operating Ambient Temperature | : | -40°C ∼ + 105°C                                                            |
|                                                    | Package                       | : | QFN0404-24C                                                                |
|                                                    | Environmentally Friendly      | : | EU RoHS Compliant, Pb Free                                                 |

### ■ TYPICAL APPLICATION CIRCUIT

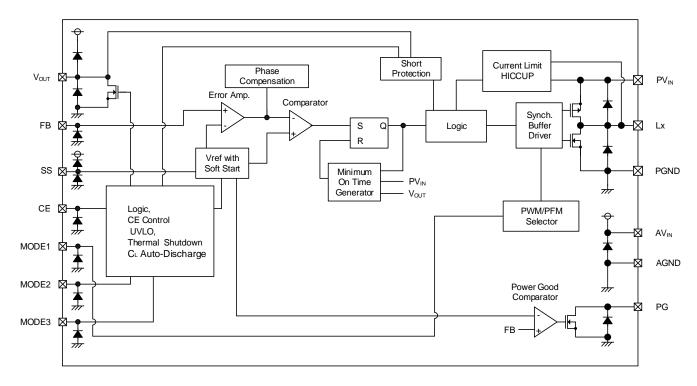


### ■TYPICAL PERFORMANCE CHARACTERISTICS



### BLOCK DIAGRAM

•XC9266



\* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

### ■ PRODUCT CLASSIFICATION

#### 1) Ordering Information

XC9266123456-7

| DESIGNATOR        | ITEM                         | SYMBOL | DESCRIPTION                                                                                     |  |
|-------------------|------------------------------|--------|-------------------------------------------------------------------------------------------------|--|
| 1                 | Туре                         | В      | Refer to Selection Guide                                                                        |  |
| 23                | Adjustable Output<br>Voltage | 06     | Output voltage can be adjustable.PWM control: 0.6V ~ 3.6VPWM/PFM automatic control: 0.8V ~ 3.6V |  |
|                   | Oppillation Fragueney        | С      | 1.2MHz                                                                                          |  |
| 4                 | Oscillation Frequency        | D      | 3.0MHz                                                                                          |  |
| <b>56</b> -7 (*1) | Package (Order Unit)         | ZR-G   | QFN0404-24C (1,000pcs/Reel)                                                                     |  |

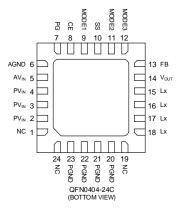
<sup>(\*1)</sup> The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

#### 2) Selection Guide

| TYPE | C∟AUTO-DISCHARGE<br>with SOFT-OFF | SHORT PROTECTION<br>with LATCH<br>or<br>HICCUP MODE | UVLO | CHIP ENABLE |
|------|-----------------------------------|-----------------------------------------------------|------|-------------|
| В    | Yes                               | Yes                                                 | Yes  | Yes         |

| TYPE | CURRENT LIMT | SOFT-START TIME | THERMAL SHUTDOWN | POWER GOOD |
|------|--------------|-----------------|------------------|------------|
| В    | Yes          | Adjustable      | Yes              | Yes        |

### ■ PIN CONFIGURATION



\* The dissipation pad for the QFN0404-24C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the GND (No. 6,20,21,22,23) pin.

| PIN NUMBER  | PIN NAME | FUNCTIONS                   |  |
|-------------|----------|-----------------------------|--|
| 1,          | NC       | No Connection               |  |
| 2,3,4       | PVIN     | Power Supply Voltage Input  |  |
| 5           | AVIN     | Analog Supply Voltage Input |  |
| 6           | AGND     | Analog Ground               |  |
| 7           | PG       | Power-good Output           |  |
| 8           | CE       | Chip Enable                 |  |
| 9           | MODE1    | Control Mode Select         |  |
| 10          | SS       | Soft start                  |  |
| 11          | MODE2    | Protection Function Select  |  |
| 12          | MOED3    | SOFT-OFF Select             |  |
| 13          | FB       | Output Voltage Sense        |  |
| 14          | Vout     | Output Voltage Sense        |  |
| 15,16,17,18 | Lx       | Switching Output            |  |
| 19          | NC       | No Connection               |  |
| 20,21,22,23 | PGND     | Power Ground                |  |
| 24          | NC       | No Connection               |  |

### ■ PIN ASSIGNMENT

### **FUNCTION**

| PIN NAME | SIGNAL | STATUS   |
|----------|--------|----------|
| CE       | L      | Stand-by |
|          | Н      | Active   |

Please do not leave the CE pin open.

| PIN NAME | SIGNAL | STATUS                                      |
|----------|--------|---------------------------------------------|
| MODE1    | L      | PWM/PFM automatic control                   |
| MODET    | Н      | PWM control                                 |
| MODE2    | L      | SHORT PROTECTION with LATCH                 |
| WIODEZ   | Н      | HICCUP MODE                                 |
| MODE3    | L      | C∟ AUTO-DISCHARGE                           |
| WIODE3   | Н      | C <sub>L</sub> AUTO-DISCHARGE with SOFT-OFF |

Please do not leave the MODE1, MODE2, MODE3 pin open

### ■ABSOLUTE MAXIMUM RATINGS

| PARAMETER                      | SYMBOL             | RATINGS                                             | UNITS |
|--------------------------------|--------------------|-----------------------------------------------------|-------|
| Power Input Voltage            | VPVIN              | -0.3 ~ 6.2                                          | V     |
| Analog Input Voltage           | Vavin              | -0.3 ~ 0.2                                          | v     |
| Lx PIN Voltage                 | V <sub>Lx</sub>    | -0.3 ~ V <sub>IN</sub> + 0.3 or 6.2 <sup>(*1)</sup> | V     |
| Output Voltage                 | Vout               | -0.3 ~ V <sub>IN</sub> + 0.3 or 4.0 <sup>(*2)</sup> | V     |
| Feedback Input Voltage         | V <sub>FB</sub>    | -0.3 ~ 6.2                                          | V     |
| CE Input Voltage               | VCE                | -0.3 ~ 6.2                                          | V     |
| MODE1 Input Voltage            | V <sub>MODE1</sub> | -0.3 ~ 6.2                                          | V     |
| MODE2 Input Voltage            | V <sub>MODE2</sub> | -0.3 ~ 6.2                                          | V     |
| MODE3 Input Voltage            | V <sub>MODE3</sub> | -0.3 ~ 6.2                                          | V     |
| PG Input Voltage               | V <sub>PG</sub>    | -0.3 ~ 6.2                                          | V     |
| Soft Start Input Voltage       | VSoftStart         | -0.3 ~ V <sub>IN</sub> + 0.3 or 6.2 <sup>(*1)</sup> | V     |
| Power Dissipation<br>(Ta=25°C) | Pd                 | 1500 (40mm x 40mm Standard board) (*3)              | mW    |
| Operating Ambient Temperature  | Topr               | -40 ~ 105                                           | C°    |
| Storage Temperature            | Tstg               | -55 ~ 125                                           | C°    |

All voltages are described based on the GND (AGND and PGND) pin.

 $^{(^{\ast}1)}$  The maximum value should be either  $V_{\text{IN}}$  + 0.3V or 6.2V in the lowest.

 $^{(^{\ast}2)}$  The maximum value should be either  $V_{\text{IN}}$  + 0.3V or 4.0V in the lowest.

 $^{(\mbox{\tiny "3)}}$  The power dissipation figure shown is PCB mounted and is for reference only.

Please refer to PACKAGING INFORMATION for the mounting condition.

## ■ELECTRICAL CHARACTERISTICS

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| PARAMETER                                        | SYMBOL                                           | CONDITIONS                                                                                                                                                                                                                                                                                                                                        |                                                               | MIN.       | TYP.  | MAX.       | UNITS  | CIRCUIT    |
|--------------------------------------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------|------------|-------|------------|--------|------------|
|                                                  |                                                  |                                                                                                                                                                                                                                                                                                                                                   | Ta=25°C                                                       | 0.594      | 0.600 | 0.606      | V      |            |
| Feedback Voltage                                 | V <sub>FB</sub>                                  | $V_{IN}=5.0V, V_{CE}=V_{MODE1}=V_{MODE2}=V_{IN}$<br>$V_{MODE3}=0.0V,$                                                                                                                                                                                                                                                                             | Ta=0°C~<br>85°C <sup>(*9)</sup>                               | 0.594      | 0.600 | 0.606      | V      | 4          |
| , i i i i i i i i i i i i i i i i i i i          |                                                  | Voltage to start oscillation while $V_{FB}$ =0.66V $\rightarrow$ 0.54V                                                                                                                                                                                                                                                                            | Ta=-40°C~<br>105°C <sup>(*9)</sup>                            | 0.591      | 0.600 | 0.609      | V      | -          |
| Load Regulation                                  |                                                  | $V_{IN}=5.0V^{(*1)}, V_{CE}=V_{MODE1}=V_{MODE2}=V_{IN}$<br>$V_{MODE3}=0.0V, I_{OUT}=0mA \sim 6.0A$                                                                                                                                                                                                                                                |                                                               | -          | 0.13  | -          | %      | 1          |
| Operating Voltage Range                          | V <sub>IN</sub>                                  |                                                                                                                                                                                                                                                                                                                                                   |                                                               | 2.7        | -     | 5.5        | V      | 1          |
| Setting Output<br>Voltage Range                  | VOUTSET                                          |                                                                                                                                                                                                                                                                                                                                                   | V <sub>MODE1</sub> =V <sub>IN</sub><br>V <sub>MODE1</sub> =0V | 0.6<br>0.8 | -     | 3.6<br>3.6 | V<br>V | 1          |
| Maximum Output Current                           | IOUTMAX                                          | V <sub>IN</sub> =2.7V ~ 5.5V <sup>(*1)</sup>                                                                                                                                                                                                                                                                                                      |                                                               | 6.0        | -     | -          | А      | 1          |
| UVLO Voltage <sup>(2)</sup>                      | V <sub>UVLO</sub>                                | $\label{eq:VcE} \begin{array}{l} V_{CE} = V_{IN},  V_{OUT} = 0.4 V,  V_{FB} = 0.54 V, \\ V_{MODE1} = V_{MODE2} = V_{IN},  V_{MODE3} = 0.0 V \\ Voltage \mbox{ which } Lx \mbox{ pin holding "L" level"} \end{array}$                                                                                                                              | )                                                             | 2.20       | -     | 2.68       | V      | 4          |
| Quiescent Current                                | lq                                               | V <sub>IN</sub> =5.0V, V <sub>CE</sub> =V <sub>IN</sub> , V <sub>OUT</sub> =V <sub>FB</sub> =0.66V<br>V <sub>MODE1</sub> =0.0V, V <sub>MODE2</sub> =V <sub>IN</sub> , V <sub>MODE3</sub> =0.0V                                                                                                                                                    |                                                               | -          | 40    | 80         | μA     | 2          |
| Stand-by Current                                 | I <sub>STB</sub>                                 | V <sub>IN</sub> =5.0V, V <sub>CE</sub> =V <sub>OUT</sub> =V <sub>FB</sub> =0.0V<br>V <sub>MODE1</sub> =V <sub>MODE2</sub> =V <sub>MODE3</sub> =0.0V                                                                                                                                                                                               |                                                               | -          | 0.0   | 10.0       | μA     | 2          |
| Minimum ONI time                                 |                                                  | When connected to external components,                                                                                                                                                                                                                                                                                                            | 1.2MHz                                                        | 350        | 500   | 650        | ns     | (1)        |
| Minimum ON time                                  | t <sub>ONmin</sub>                               | V <sub>IN</sub> =3.0V, V <sub>OUT</sub> =1.8V I <sub>OUT</sub> =1mA<br>V <sub>CE</sub> =V <sub>MODE1</sub> =V <sub>MODE2</sub> =V <sub>IN</sub> , V <sub>MODE3</sub> =0.0V                                                                                                                                                                        | 3.0MHz                                                        | 140        | 200   | 260        | ns     |            |
| Thermal shutdown                                 | T <sub>TSD</sub>                                 | -                                                                                                                                                                                                                                                                                                                                                 |                                                               | -          | 150   | -          | °C     | 1          |
| Thermal shutdown<br>hysteresis                   | T <sub>HYS</sub>                                 | -                                                                                                                                                                                                                                                                                                                                                 |                                                               | -          | 20    | -          | °C     | 1          |
|                                                  |                                                  | VIN=5.0V, VCE=VMODE1=VMODE2=VIN,                                                                                                                                                                                                                                                                                                                  | 1.2MHz,                                                       | -          | 95    | -          | ~      | •          |
| Efficiency <sup>(*3)</sup>                       | EFFI                                             | V <sub>MODE3</sub> =0.0V,V <sub>OUT</sub> =3.3V, I <sub>OUT</sub> =1.0A                                                                                                                                                                                                                                                                           | 3.0MHz,                                                       | -          | 92    | -          | ~ %    | 1          |
| Lx SW "H" ON<br>Resistance                       | R <sub>LXH</sub>                                 |                                                                                                                                                                                                                                                                                                                                                   |                                                               | -          | 32    | 70         | mΩ     | 3          |
| Lx SW "L" ON Resistance                          | R <sub>LXL</sub>                                 |                                                                                                                                                                                                                                                                                                                                                   |                                                               | -          | 25    | 60         | mΩ     | 3          |
| Lx SW"H" Leakage<br>Current <sup>(*6)</sup>      | I <sub>LeakH</sub>                               |                                                                                                                                                                                                                                                                                                                                                   | V <sub>Lx</sub> =5.5V                                         | -          | 0.0   | 50.0       | μA     | 5          |
| Lx SW"L" Leakage<br>Current <sup>(*7)</sup>      | I <sub>LeakL</sub>                               | $V_{IN}$ = 5.5V, $V_{FB}$ =0.66V, $V_{OUT}$ = $V_{CE}$ =0.0V, $V_{MODE1}$ =0.0V, $V_{MODE2}$ = $V_{IN}$ , $V_{MODE3}$ =0.0V                                                                                                                                                                                                                       | V <sub>Lx</sub> =0.0V                                         | -          | 0.0   | 10.0       | μA     | 5          |
| Current Limit (*8)                               | I <sub>LIM</sub>                                 | $ \begin{array}{l} V_{\text{IN}}{=}5.0V, \ V_{\text{CE}}{=}V_{\text{IN}}, \ V_{\text{OUT}}{=}V_{\text{FB}}{=}0.54V \\ V_{\text{MODE1}}{=}0.0V, \ V_{\text{MODE2}}{=}V_{\text{IN}}, \ V_{\text{MODE3}}{=}0 \\ ILx \ until \ Lx \ pin \ oscillates \end{array} $                                                                                    |                                                               | 9.0        | 10.0  | 13.0       | A      | 6          |
| Output Voltage<br>Temperature<br>Characteristics | ⊿V <sub>о∪т</sub> /<br>(V <sub>о∪т</sub> ∙⊿Topr) | I <sub>o∪T</sub> =30mA, -40°C≦Topr≦105°C                                                                                                                                                                                                                                                                                                          |                                                               | -          | ±30   | -          | ppm/°C | 1          |
| PG detect voltage                                | $V_{PG}$                                         | $\begin{split} &V_{\text{IN}=5.0V, \ V_{\text{CE}}=V_{\text{IN}, \ V_{\text{OUT}}=0.54V, \ V_{\text{MODE1}}=0.0V, \\ &V_{\text{MODE2}}=V_{\text{IN}, \ V_{\text{MODE3}}=0.0V, \ PG=Pull \ up \ 10k \ \Omega(V_{\text{IN}}) \\ &V_{\text{FB}}=0.58V {\rightarrow} 0.42V, \ Voltage \ which \ PG \ pin \ holding \ ``L'' \ level^{(5)} \end{split}$ |                                                               | 0.42       | 0.50  | 0.58       | V      | 4          |
| PG Output Current                                | I <sub>PG</sub>                                  | $\begin{split} V_{\text{IN}}{=}5.0V, \ V_{\text{CE}}{=}V_{\text{IN}}, \ V_{\text{OUT}}{=}0.54V \\ V_{\text{MODE1}}{=}0.0V, \ V_{\text{MODE2}}{=}V_{\text{IN}}, \ V_{\text{MODE3}}{=}0.0V \\ V_{\text{FB}}{=}0.42V, \ PG = 0.5V \end{split}$                                                                                                       |                                                               | 3.6        | 4.5   | 5.5        | mA     | 4          |
| Soft-Start Time1                                 | t <sub>SS1</sub>                                 | $V_{IN}$ =5.0V, $V_{OUT}$ = $V_{FB}$ =0.54V, $V_{MODE}$ 1=0.0V, $V_{MODE}$<br>$V_{MODE3}$ =0.0V, $V_{CE}$ =0.0V $\rightarrow$ 3.6V, Time from $V_{CE}$ =                                                                                                                                                                                          |                                                               | 0.10       | 0.25  | 0.50       | ms     | $\bigcirc$ |

are generated at Lx pin.  $C_{\mbox{\scriptsize SS}}$  = open

 $V_{IN}{=}5.0V, \ V_{OUT}{=}V_{FB}{=}0.54V, \ V_{MODE\,1}{=}0.0V, \ V_{MODE2}{=}V_{IN},$ 

 $V_{\text{MODE3}}{=}0.0V,\,V_{\text{CE}}{=}0.0V{\rightarrow}$  3.6V, Time from  $V_{\text{CE}}{=}3.6V$  to clocks are generated at Lx pin. Css=3300pF

1.0

2.5

5.0

ms

 $\bigcirc$ 

Soft-Start Time2

t<sub>SS2</sub>

### ■ ELECTRICAL CHARACTERISTICS (Continued)

●XC9266 Series

| PARAMETER                             | SYMBOL              | CONDITIONS                                                                                                                                                                                                                                                                                                                                                            | MIN.    | TYP.     | MAX.   | UNITS | Ta=25°<br>CIRCUIT |
|---------------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|----------|--------|-------|-------------------|
| PARAIVIETER                           | STIMBOL             |                                                                                                                                                                                                                                                                                                                                                                       | IVIIIN. | TTP.     | IVIAA. | UNITS | CIRCUII           |
| Soft-Off Time                         | t <sub>so</sub>     | $V_{IN}=5.0V, V_{MODE1}=V_{MODE2}=V_{MODE3}=V_{IN},$<br>$C_L=47uF, V_{OUT}=1.8V, V_{CE}=5.0V\rightarrow0.0V$                                                                                                                                                                                                                                                          | 0.05    | 0.10     | 0.15   | ms    | 1                 |
|                                       |                     | Time from $V_{CE}=0.0V$ to $V_{OUT}=0.2V$                                                                                                                                                                                                                                                                                                                             |         |          |        |       |                   |
| C <sub>L</sub> Discharge              | R <sub>DCHG</sub>   | $V_{IN}$ =5.0V, $V_{CE}$ =0.0V, $V_{FB}$ =0.66V,                                                                                                                                                                                                                                                                                                                      | _       | 65       | 130    | Ω     | 8                 |
| g-                                    | - Dene              | $V_{MODE1}=V_{MODE2}=V_{IN}, V_{MODE3}=0.0V, V_{OUT}=0.2V$                                                                                                                                                                                                                                                                                                            |         |          |        |       |                   |
| 111 5.2                               |                     | $V_{\text{IN}}=5.0V, V_{\text{CE}}=V_{\text{MODE1}}=V_{\text{MODE2}}=V_{\text{IN}}, V_{\text{MODE3}}=0.0V,$                                                                                                                                                                                                                                                           | 4.0     | <u> </u> |        |       |                   |
| Hiccup wait time                      | t <sub>HW</sub>     | $C_{SS}$ =3300pF, $V_{OUT}$ =0.0V, Time from the oscillation stop until the oscillation start                                                                                                                                                                                                                                                                         | 1.0     | 2.5      | 5.0    | ms    | 1                 |
| MODE1 "H" Voltage                     | V <sub>MODE1H</sub> | Applied voltage to $V_{MODE1}$ , Voltage for PWM Control                                                                                                                                                                                                                                                                                                              | 1.4     | -        | 5.5    | V     | 1                 |
| 0                                     |                     | Applied voltage to $V_{MODE1}$ ,                                                                                                                                                                                                                                                                                                                                      |         |          |        |       |                   |
| MODE1 "L" Voltage                     | V <sub>MODE1L</sub> | Voltage for PWM/PFM automatic control                                                                                                                                                                                                                                                                                                                                 | AGND    | -        | 0.5    | V     | 1                 |
| MODE2 "H" Voltage                     | V <sub>MODE2H</sub> | Applied voltage to $V_{MODE2}$ , Voltage for HICCUP MODE                                                                                                                                                                                                                                                                                                              | 1.4     | -        | 5.5    | V     | 4                 |
| MODE2 "L" Voltage                     | V <sub>MODE2L</sub> | Applied voltage to V <sub>MODE2</sub> ,<br>Voltage for SHORT PROTECTION with LATCH                                                                                                                                                                                                                                                                                    | AGND    | -        | 0.5    | V     | 4                 |
| MODE3 "H" Voltage                     | V <sub>MODE3H</sub> | Applied voltage to $V_{MODE3}$ , Voltage for<br>C <sub>L</sub> Auto-Discharge with SOFT-OFF                                                                                                                                                                                                                                                                           | 1.4     | -        | 5.5    | V     | 1                 |
| MODE3 "L" Voltage                     | V <sub>MODE3L</sub> | Applied voltage to $V_{MODE3}$ , Voltage for $C_L$ Auto-Discharge                                                                                                                                                                                                                                                                                                     | AGND    | -        | 0.5    | V     | 1                 |
| MODE1 "H" Current                     | I <sub>MODE1H</sub> | V <sub>IN</sub> =5.5V,V <sub>CE</sub> =0.0V,V <sub>MODE1</sub> =5.5V,V <sub>MODE2</sub> =5.5V, V <sub>MODE3</sub> =5.5V                                                                                                                                                                                                                                               | -0.1    | -        | 0.1    | μA    | 5                 |
| MODE1 "L" Current                     | I MODE1L            | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =0.0V, V <sub>MODE1</sub> =0.0V,<br>V <sub>MODE2</sub> =0.0V, V <sub>MODE3</sub> =0.0V                                                                                                                                                                                                                                         | -0.1    | -        | 0.1    | μA    | 5                 |
| MODE2 "H" Current                     | I <sub>MODE2H</sub> | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =0.0V, V <sub>MODE1</sub> =5.5V,<br>V <sub>MODE2</sub> =5.5V, V <sub>MODE3</sub> =5.5V                                                                                                                                                                                                                                         | -0.1    | -        | 0.1    | μA    | 5                 |
| MODE2 "L" Current                     | I <sub>MODE2L</sub> | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =0.0V, V <sub>MODE1</sub> =0.0V,<br>V <sub>MODE2</sub> =0.0V, V <sub>MODE3</sub> =0.0V                                                                                                                                                                                                                                         | -0.1    | -        | 0.1    | μA    | 5                 |
| MODE3 "H" Current                     | I MODE 3H           | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =0.0V, V <sub>MODE1</sub> =5.5V,<br>V <sub>MODE2</sub> =5.5V, V <sub>MODE3</sub> =5.5V                                                                                                                                                                                                                                         | -0.1    | -        | 0.1    | μA    | 5                 |
| MODE3 "L" Current                     | I MODE 3L           | $V_{IN}=5.5V, V_{CE}=0.0V, V_{MODE1}=0.0V, V_{MODE2}=0.0V, V_{MODE3}=0.0V$                                                                                                                                                                                                                                                                                            | -0.1    | -        | 0.1    | μA    | 5                 |
| CE "H" Voltage                        | V <sub>CEH</sub>    | $\label{eq:VINESCOV} \begin{split} V_{\text{IN}} = & 5.0 \text{V}, \ V_{\text{OUT}} = & V_{\text{FB}} = & 0.54 \text{V} \\ V_{\text{MODE1}} = & 0.0 \text{V}, \ V_{\text{MODE2}} = & V_{\text{IN}}, \ V_{\text{MODE3}} = & 0.0 \text{V} \\ \text{Applied voltage to } & V_{\text{CE}} \ \text{Voltage changes Lx to} \\ \text{``H'' level} \ \text{``5)} \end{split}$ | 1.4     | -        | 5.5    | V     | 4                 |
| CE "L" Voltage                        | V <sub>CEL</sub>    | $\label{eq:V_IN=5.0V, V_{OUT}=V_{FB}=0.54V} \\ V_{MODE1}=0.0V, V_{MODE2}=V_{IN}, V_{MODE3}=0.0V \\ Applied voltage to V_{CE} Voltage changes Lx to "L" level ^{(5)}$                                                                                                                                                                                                  | AGND    | -        | 0.5    | V     | 4                 |
| CE "H" Current                        | I <sub>CEH</sub>    | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =5.5V, V <sub>MODE1</sub> =5.5V, V <sub>MODE2</sub> =5.5V, V <sub>MODE3</sub> =5.5V,                                                                                                                                                                                                                                           | -0.1    | -        | 0.1    | μA    | 5                 |
| CE "L" Current                        | I <sub>CEL</sub>    | V <sub>IN</sub> =5.5V, V <sub>CE</sub> =0.0V, V <sub>MODE1</sub> =0.0V,<br>V <sub>MODE2</sub> =0.0V, V <sub>MODE3</sub> =0.0V                                                                                                                                                                                                                                         | -0.1    | -        | 0.1    | μA    | 5                 |
| Short Protection<br>Threshold Voltage | V <sub>SHORT</sub>  | $V_{IN}$ =5.0V, $V_{CE}$ = $V_{IN}$ , $V_{FB}$ =0.54V<br>$V_{MODE1}$ = $V_{IN}$ , $V_{MODE2}$ =0.0V, $V_{MODE3}$ =0.0V<br>Sweeping $V_{OUT}$ , voltage which Lx becomes "L" level <sup>(*5)</sup>                                                                                                                                                                     | 0.10    | 0.20     | 0.50   | V     | 4                 |

Unless otherwise stated, V\_{IN}=5.0V, V\_{CE}=5.0V, V\_{MODE1}=0.0V, V\_{MODE2}=0.0V, V\_{MODE3}=0.0V

<sup>(\*1)</sup> When the difference between the input and the output is small, 100% duty might come up and internal control circuits keep Pch MOS driver turning on even though the output current is not so large.

If current is further pulled from this state, output voltage will decrease because of Pch MOS driver ON resistance.

<sup>(\*2)</sup> Including UVLO detect voltage, hysteresis operating voltage range for UVLO release voltage.

<sup>(\*3)</sup> EFFI = [(output voltage × output current) ÷ (input voltage × input current)] × 100

(\*4) R<sub>LXH</sub>= (V<sub>IN</sub> - Lx pin measurement voltage) / 100mA, R<sub>LXL</sub>= Lx pin measurement voltage / 100mA

 $^{(*5)}$  "H"=V<sub>IN</sub> - 1.2V ~ V<sub>IN</sub>, "L"= -0.1V ~ 0.1V

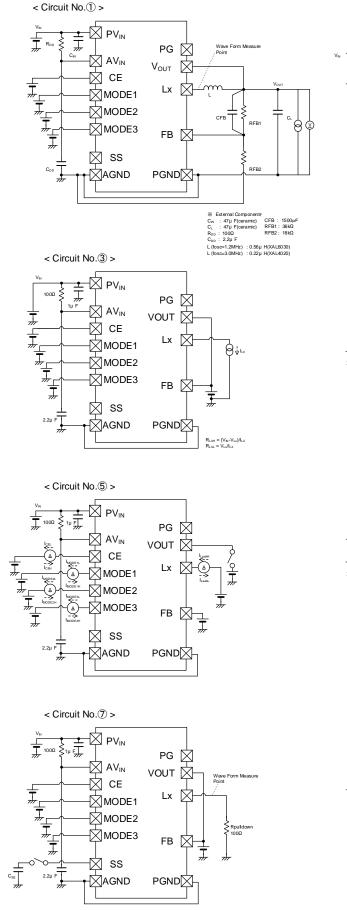
 $^{(^{6})}$  When temperature is high, a current of approximately 150  $\mu A$  (maximum) may leak.

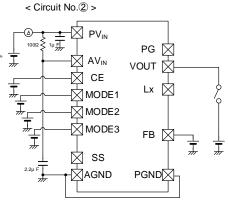
<sup>('7)</sup> When temperature is high, a current of approximately 50µA (maximum) may leak.

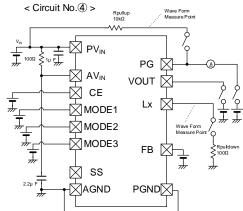
(\*8) Current limit denotes the level of detection at peak of Pch MOS driver Tr. current.

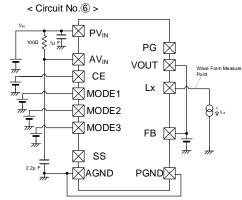
(\*9) Design value

### TEST CIRCUITS

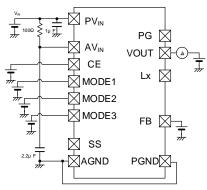




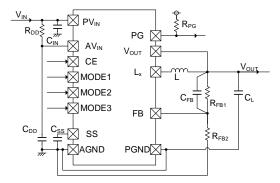








### ■TYPICAL APPLICATION CIRCUIT



#### [Typical Examples] fosc=1.2MHz

|   | MANUFACTURER | PRODUCT NUMBER   | VALUE  | $SIZE(L \times W \times T)$ |
|---|--------------|------------------|--------|-----------------------------|
|   | Cailaratt    | XAL6030-561MEB   | 0.56µH | 6.36×6.56×3.1(mm)           |
| L | Coilcraft    | XFL7015-471ME    | 0.47µH | 7.5 × 7.5 × 1.5(mm)         |
|   | TDK          | SPM6530T-R47M170 | 0.47µH | 7.1 × 6.5 × 3.0(mm)         |

#### [Typical Examples] fosc=3.0MHz

|   | MANUFACTURER | PRODUCT NUMBER   | VALUE  | $SIZE(L \times W \times T)$ |
|---|--------------|------------------|--------|-----------------------------|
|   | Cailaraft    | XAL4020-221MEB   | 0.22µH | 4.0×4.0×2.1(mm)             |
| L | Coilcraft    | XFL7015-251ME    | 0.25µH | 7.5 × 7.5 × 1.5(mm)         |
|   | TDK          | SPM6530T-R25M230 | 0.25µH | 7.1 × 6.5 × 3.0(mm)         |

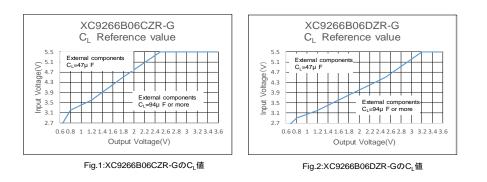
#### [Typical Examples] $\ ^{(*1)}$ fosc=1.2MHz, fosc=3.0MHz

|                 | MANUFACTURER | PRODUCT NUMBER     | VALUE                     | $SIZE(L \times W \times T)$ |  |
|-----------------|--------------|--------------------|---------------------------|-----------------------------|--|
|                 | murata       | GRM31CR61A476ME15L | 47µF/10V                  | 3.2×1.6×1.6(mm)             |  |
| CIN             | TAIYO YUDEN  | LMK316ABJ476ML-T   | 47µF/10V                  | 3.2×1.6×1.6(mm)             |  |
|                 | TDK          | C3216X6S1A476M     | 47µF/10V                  | 3.2×1.6×1.6(mm)             |  |
|                 | murata       | GRM31CR60J476ME19L | 47µF/6.3V <sup>(*2)</sup> | 3.2×1.6×1.6(mm)             |  |
|                 | murata       | GRM32ER71A476KE15L | 47µF/10V <sup>(*2)</sup>  | 3.2 × 2.5 × 2.5(mm)         |  |
| CL              | TAIYO YUDEN  | JMK316ABJ476ML-T   | 47µF/6.3V <sup>(*2)</sup> | 3.2×1.6×1.6(mm)             |  |
|                 | TAITO TUDEN  | LMK325B7476KM-PR   | 47µF/10V <sup>(*2)</sup>  | 3.2×2.5×2.5(mm)             |  |
|                 | TDK          | C3216X6S0J476M     | 47µF/6.3V <sup>(*2)</sup> | 3.2×1.6×1.6(mm)             |  |
| C <sub>SS</sub> |              |                    | 330pF <sup>(*3)</sup>     |                             |  |
| R <sub>DD</sub> |              |                    | 100Ω                      |                             |  |
|                 | murata       | GRM155R61A225KE95D | 2.2µF/10V                 | 1.0×0.5×0.5 (mm)            |  |
| CDD             | TAIYO YUDEN  | LMK105BJ225MV-F    | 2.2µF/10V                 | 1.0×0.5×0.5 (mm)            |  |
| Rpg             |              |                    | 100kΩ                     |                             |  |

(\*1) Select components appropriate to the usage conditions (ambient temperature, input & output voltage).

 $^{(^{\ast}2)}$  Regarding the value of CL, please refer to Fig.1, Fig.2

 $^{(*3)}$  Can also be used without C<sub>SS</sub> (SS pin OPEN). When used without C<sub>SS</sub>, the IC starts at the soft start time set internally.



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### ■TYPICAL APPLICATION CIRCUIT(Continued)

< Output voltage setting >

The output voltage can be set by adding an external dividing resistor. The output voltage is determined by the equation below based on the values of  $R_{FB1}$  and  $R_{FB2}$ .

 $V_{OUT} = 0.6 \times (R_{FB1} + R_{FB2})/R_{FB2}$  with  $R_{FB1}, R_{FB2} \leq 100 k\Omega$ 

Adjust the value of the phase compensation speed-up capacitor. Adjust the  $C_{FB}$  value so that  $fzfb = 1/(2 \times \pi C_{FB} \times R_{FB1})$  is about 3kHz

Output voltage setting range is 0.6V to 3.6V in PWM control, PFM/PWM automatic switching control is 0.8V to 3.6V.

| [Setting E | xample】 |
|------------|---------|
|------------|---------|

| Vout | R <sub>FB1</sub> | R <sub>FB2</sub> | C <sub>FB</sub> | Vout | R <sub>FB1</sub> | R <sub>FB2</sub> | CFB    |
|------|------------------|------------------|-----------------|------|------------------|------------------|--------|
| 0.6V | 0Ω               | Open             | Open            | 1.8V | 36kΩ             | 18kΩ             | 1500pF |
| 0.7V | 11kΩ             | 62kΩ             | 4700pF          | 3.3V | 68kΩ             | 15kΩ             | 820pF  |
| 1.2V | 91kΩ             | 91kΩ             | 560pF           |      |                  |                  |        |

< Inductance value setting >

In the XC9266 series, it is optimum to set an inductance value within the range below based on the set frequency.

foscset: Set frequency

| foscset | Inductance value |  |
|---------|------------------|--|
| 3.0MHz  | 0.22µH ~ 0.25µH  |  |
| 1.2MHz  | 0.47µH ~ 0.56µH  |  |

< Soft-start function >

The soft start time of the XC9266 series can be adjusted externally (SS pin). The soft start time is the time from the start of  $V_{CE}$  until the output voltage reaches 90% of the set voltage. The soft start time depends on the external capacitance  $C_{SS}$ , and is determined by the equation below.

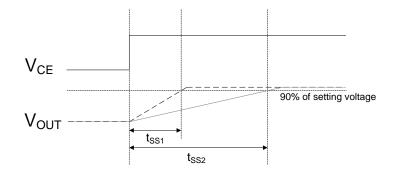
tss2(ms) = 1.5 x Css / Iss Css: External capacitance (nF) Iss: 2.0 (μA)

\* Note that the value of the soft start time  $t_{SS2}$  varies depending on the effective capacitance value of the delay capacitance  $C_{SS}$  and  $I_{SS}$ .

[Calculation Example]

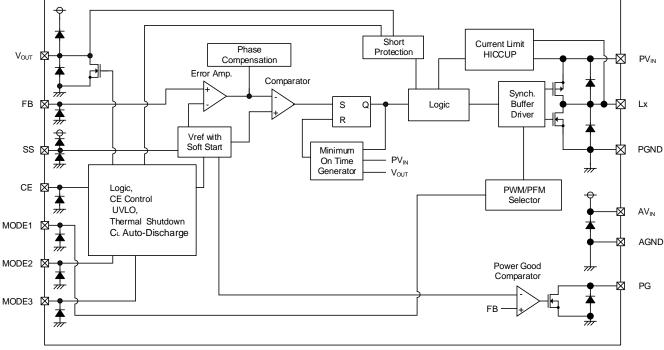
When Css=3.3nF tss2=1.5x3.3/{2 $\mu$ A}=2.475ms

The minimum value t<sub>SS2</sub> of the soft-start time is set internally.



### ■OPERATIONAL EXPLANATION

The XC9266 series consists of a reference voltage source, error amplifier, comparator, phase compensation, minimum on time generation circuit, output voltage adjustment resistors, P-channel MOS driver transistor, N-channel MOS switching transistor for the synchronous switch, current limiter circuit, UVLO circuit, thermal shutdown circuit, short protection circuit, PWM/PFM selection circuit and others. (See the BLOCK DIAGRAM below.)



BLOCK DIAGRAM (XC9266 Series Type B)

The method is HiSAT-COT (High Speed circuit Architecture for Transient with Constant On Time) control, which features on time control method and a fast transient response that also achieves low output voltage ripple.

The on time (t<sub>on</sub>) is determined by the input voltage and output voltage, and turns on the Pch MOS driver Tr. for a fixed time. During the off time (t<sub>off</sub>), the voltage is generated by resistor division with resistors R<sub>FB1</sub> and R<sub>FB2</sub>. The voltage is compared to the reference voltage by the error amp, and the error amp output is phase compensated and sent to the comparator. The comparator compares this signal to the reference voltage, and if the signal is lower than the reference voltage, sets the SR latch. On time then resumes. By doing this, PWM operation takes place with the off time controlled to the optimum duty ratio and the output voltage is stabilized. The phase compensation circuit optimizes the frequency characteristics of the error amp, and generates a ramp wave similar to the ripple voltage that occurs in the output to modulate the output signal of the error amp. This enables a stable feedback system to be obtained even when a low ESR capacitor such as a ceramic capacitor is used, and a fast transient response and stabilization of the output voltage are achieved.

< Minimum on time generation circuit >

Generates an on time that depends on the input voltage and output voltage ( $t_{on}$ ). The on time is set as given by the equations below.

< Switching frequency >

The switching frequency can be obtained from the on time  $(t_{on})$ , which is determined by the input voltage and output voltage, and the PWM controlled off time  $(t_{off})$  as given by the equation below.

 $f_{OSC} (MHz) = V_{OUT}(V) / (V_{IN}(V) \times t_{on}(\mu s))$ 

#### <100% duty cycle mode >

When the load current is heavy and the voltage difference between input voltage and output voltage is small, 100% duty cycle mode is activated and it keeps the Pch MOS driver Tr. keep on. 100% duty cycle mode attains a high output voltage stability and a high-speed response under all load conditions, from light to heavy, even in conditions where the dropout voltage is low.



### ■ OPERATIONAL EXPLANATION (Continued)

#### < Error amp >

The error amp monitors the output voltage. The voltage divided by the external R<sub>FB1</sub> and R<sub>FB2</sub> resistors is a feedback voltage for Error Amp. and compared to the reference voltage. The output voltage of the error amp becomes higher when the feedback voltage is higher than the reference voltage. The frequency characteristics of the error amp are optimized internally.

#### < Reference voltage source, soft start function >

The reference voltage forms a reference that is used to stabilize the output voltage of the IC.

After "H" level is fed to CE pin, the reference voltage connected to the error amp increases linearly during the soft start interval. This allows the voltage divided by the external  $R_{FB1}$  and  $R_{FB2}$  resistors and the reference voltage to be controlled in a balanced manner, and the output voltage rises in proportion to the rise of the reference voltage. This operation prevents rush input current and enables the output voltage to rise smoothly.

If the output voltage does not reach the set output voltage within the soft start time, for example a case when the load is heavy or a large capacity output capacitor is connected, the balance between the feedback voltage and the reference voltage is lost, however, the current limit function is activated in order to prevent an excessive increase of input current, enabling a smooth rise of the output voltage.

#### < Control system selection circuit >

XC9266 series is selectable on the control method between PWM control and PWM/PFM auto switching control by using MODE1 pin. When "H" level is fed to MODE1 pin, XC9266 works with PWM control, whereas when "L" level is fed to MODE1 pin, it works with PWM/PFM auto switching control.

Under PWM control, XC9266 works with the continuous conduction mode (CCM) and ON-duty is decided based on the

relationship between the input voltage and the output voltage regardless the output current, and the switching frequency is stable. On the other hand, under PWM/PFM auto switching control, XC9266 can work with the discontinuous conduction mode (DCM) when the output current is low and the switching frequency varies to lower frequency so that the switching loss reduces and, as a result, the efficiency is improved. MODE1 pin has CMOS input configuration and the sink current is 0µA.

#### < CE function >

Operation starts when "H" voltage is input into the CE pin. The IC can be put in the shutdown state by inputting "L" voltage into the CE pin. In the shutdown state, the supply current of the IC is 0µA (TYP.), and the Pch MOS driver Tr. And Nch MOS switch Tr. for synchronous rectification turn off. The CE pin is a CMOS input and the sink current is 0µA.

#### < UVLO Circuit >

When the  $AV_{IN}$  voltage becomes 2.40V (TYP.) or lower, the Pch MOS driver transistor output driver transistor is forced OFF to prevent false pulse output caused by unstable operation of the internal circuitry. When the  $AV_{IN}$  pin voltage becomes 2.50V (TYP.) or higher, switching operation takes place. By releasing the UVLO function, the IC performs the soft start function to initiate output startup operation. The UVLO circuit does not cause a complete shutdown of the IC, but causes pulse output to be suspended; therefore, the internal circuitry remains in operation.

#### < Thermal Shutdown >

For protection against heat damage of the ICs, thermal shutdown function monitors chip temperature. The thermal shutdown circuit starts operating and the Pch MOS driver and Nch MOS driver transistor will be turned off when the chip's temperature reaches  $T_{TSD}(TYP. 150^{\circ}C)$ . When the temperature drops to  $T_{TSD}-T_{HYS}(TYP. 130^{\circ}C)$  or less after shutting of the current flow, the IC performs the soft-start function to initiate output startup operation.

#### < Short-circuit protection function >

Short-circuit protection circuit protects the device that is connected to this product and to the input/output in situations such as when the output is accidentally shorted to GND. The short-circuit protection circuit monitors the output voltage, and when the output voltage falls below the short-circuit protection threshold voltage, it turns off the Pch MOS driver Tr and latches it. Once in the latched state, operation is resumed by turning off the IC from the CE pin and then restarting, or by re-input into the V<sub>IN</sub> pin.

#### < Hiccup >

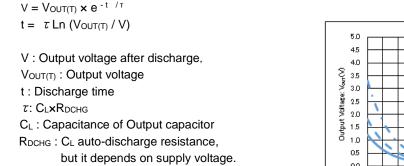
Hiccup is one of the means to protect the IC and the device connected to the IC from being damaged by an excessive temperature rise caused by the overload state in the long time.

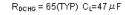
- 1 When the load current reaches the current limit, IC will be turned off.
- 2 The IC protects itself from being damaged by the heat by maintaining the off state for a constant time.
- ③ After a certain time in state ②, the IC resumes operation to check whether or not the over current condition is continuing.
- ④ If the over current state continues, the IC returns to ②. The IC restarts by a soft start if the overcurrent state is released.

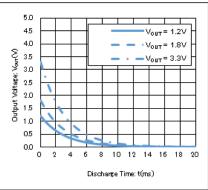
### ■OPERATIONAL EXPLANATION (Continued)

#### < C<sub>L</sub> High Speed Discharge >

 $C_L$  High Speed Discharge can quickly discharge the electric charge at the output capacitor ( $C_L$ ) via the Nch MOS switch transistor and auto-discharge resistance located between the  $V_{OUT}$  pin and the GND pin when "L" level signal is fed to CE pin and IC is disable. It can prevent a malfunction of the device connected to the output of XC9266 due to the stored electric charge at the output capacitor when XC9266 is disable.







< Soft-off function >

When H level is fed to MODE3 pin and L level is fed to CE pin, a Soft-off function is activated.

The function can discharge the electric charge in the output capacitor much faster than  $C_L$  high speed discharge function because the function can turn on an internal Nch MOS switch which is for synchronous rectification originally and use it for the discharge. (Refer to a diagram below)

This function make a power-off sequence easier because it can prevent a device connected to the output of XC9266 from a malfunction caused by the stored electric charge in the output capacitor of XC9266 when it is disable.

Furthermore, the Soft-off function regenerates energy by Nch MOS switching Tr., and the input voltage rises by the regenerative energy .The rise voltage of the input voltage can be calculated with using the following equation, once the design has been completed, verification with actual components should be required.

#### [Equation]

The rise voltage of the input voltage =  $(V_{OUT}-0.2)^2 \times C_L/(2 \times V_{IN} \times C_{IN})$ 

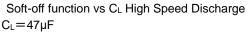
VIN: Input voltage

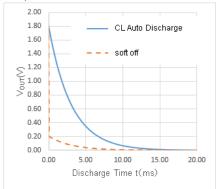
V<sub>OUT</sub> : Output voltage

 $\label{eq:CL} \begin{array}{l} C_L: \mbox{ Actual capacitance value of an output Capacitor (C_L)} \\ C_{IN}: \mbox{ Actual capacitance value of an input Capacitor (C_I)} \end{array}$ 

#### [Calculation Example]

When V<sub>IN</sub>=5.0V, V<sub>OUT</sub>=1.8V, C<sub>IN</sub>=47 $\mu$ F, C<sub>L</sub>=47 $\mu$ F The rise voltage of the input voltage=(1.8-0.2)<sup>2</sup>x(47x10<sup>-6</sup>)/(2x5.0x(47x10<sup>-6</sup>)) =0.256V





< Current Limit >

The current limiter circuit monitors the current flowing through the P-channel MOS driver transistor connected to the Lx pin. When the driver current is bigger than a specific level, the current limit function operates to turn off the pulses from the Lx pin. When the over current state is eliminated, the IC resumes its normal operation.

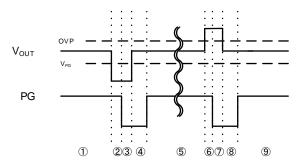


### OPERATIONAL EXPLANATION (Continued)

<Power good>

Output state can be monitored using the power good function. Connect pull-up resistor to a PG pin as its output configuration is Nch open drain. The PG pin outputs "L" signal in the following cases.

Case1: For VOUT fluctuation



 $\textcircled{\sc 1}$  The initial conditions,  $V_{\text{OUT}}$  is a stable state.

(2) When  $V_{OUT}$  falls to less than the threshold  $V_{PG}$  of the PG, PG system starts to count the internal delay (TYP=140µs). (3) PG voltage goes down to GND level after the internal delay.

(4) After V\_{OUT} goes up higher than the threshold V\_{PG} , PG system starts to count the internal delay (TYP=180  $\mu s$ ).

 $\textcircled{5}\mbox{PG}$  voltage goes up to the pull up voltage after the internal delay.

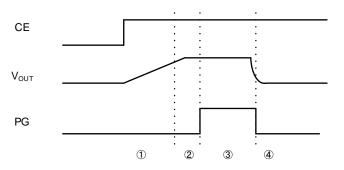
©When V<sub>OUT</sub> goes up to higher than threshold OVP, PG system starts to count the internal delay (TYP=140μs). ⑦PG voltage goes up to the pull up voltage after the internal delay.

(8) When Vout falls to less than the threshold OVP, PG system starts to count the internal delay(TYP=180µs).

(9)PG voltage goes up to the pull up voltage after the internal delay.

\* When the FB voltage becomes 0.7V of the OVP threshold and VOUT rises more than +17%, PG is made the GND level.

Case2: For Soft-start function, Thermal Shutdown, Short-circuit protection function



①Assume V<sub>IN</sub> has been applied.When H level is fed to the CE pin, V<sub>OUT</sub> will rise by using a Soft-start function. PG voltage is the GND level during Soft-start operation.

2 After VOUT goes up to 90% of the setting voltage, PG system starts to count the internal delay (TYP=140µs).

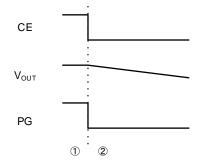
③PG voltage goes up to the pull up voltage after the internal delay.

(4) When a short circuit comes at V<sub>OUT</sub> or when thermal shut down is activated , PG voltage goes down to the GND level promptly without an internal delay.

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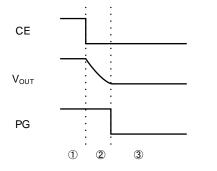
### OPERATIONAL EXPLANATION (Continued)

Case3: For C<sub>L</sub> High Speed Discharge (CE= "L" voltage)



①The initial conditions, V<sub>OUT</sub> is a stable state. Assume C<sub>L</sub> high speed Discharge is activated by using MODE3 pin.
 ②L level is fed to CE pin and then XC9266 is in a standby state. Therefore V<sub>OUT</sub> begins to fall down by a C<sub>L</sub> High Speed Discharge. In this case, PG voltage goes down to GND level promptly.

Case4: For Soft-off function (CE= "L" voltage)



① The initial conditions,  $V_{OUT}$  is a stable state. Assume Soft-off function is activated by using MODE3 pin. ②L level is fed to CE pin and then XC9266 is in a standby state. Therefore  $V_{OUT}$  begins to fall down sharply by soft-off function. In this case, PG voltage goes down to GND level ( $V_{OUT} = 0.2V$  or less) after soft-off function is completed.

### ■NOTE ON USE

- 1) For the phenomenon of temporal and transitional voltage decrease or voltage increase, the IC may be damaged or deteriorated if IC is used beyond the absolute MAX. specifications.
- 2) Spike noise and ripple voltage arise in a switching regulator as with a DC/DC converter. These are greatly influenced by external component selection, such as the coil inductance, capacitance values, and board layout of external components. Once the design has been completed, verification with actual components should be done.
- 3) The DC/DC converter characteristics depend greatly on the externally connected components as well as on the characteristics of this IC, so refer to the specifications and standard circuit examples of each component when carefully considering which components to select. Be especially careful of the capacitor characteristics and use B characteristics (JIS standard) or X7R, X5R (EIA standard) ceramic capacitors.

If the capacitance value is not sufficient by degrading CL due to the low temp. Condition and DC bias feature, the duty cycle might not be stable. Add capacitance value for CL if necessary.

- 4) Make sure that the PCB GND traces are as thick and wide as possible. The PGND pin and AGND pin fluctuation caused by high ground current at the time of switching may result in instability of the IC. Therefore, the GND traces close to the PGND pin and AGND pin are important.
- 5) Mount external components as close as possible to the IC. Keep the wiring short and thick to lower the wiring impedance.
- 6) A feature of HiSAT-COT control is that it controls the off time in order to control the duty, which varies due to the effects of power loss. In addition, changes in the on time due to 100% duty cycle mode are allowed. For this reason, caution must be exercised as the characteristics of the switching frequency will vary depending on the external component characteristics, board layout, input voltage, output voltage, load current and other parameters.
- 7) Due to propagation delay inside the product, the on time generated by the minimum on time generation circuit is not the same as the on time that is the ratio of the input voltage to the output voltage.
- 8) With regard to the current limiting value, the actual coil current may at times exceed the electrical characteristics due to propagation delay inside the product.
- 9) The CE pin is a CMOS input pin. Do not use with the pin open. If connecting to the input or ground, use the resistor not more than 1MΩ or less. To prevent malfunctioning of the device connected to this product or the input/output due to short circuiting between pins, it is recommended that a resistor be connected.
- 10) Regarding XC9266 which has PWM/PFM auto switching control method, it works with a discontinuous conduction mode at light loads, and in this case where the voltage difference between input voltage and output voltage is low or the coil inductance is higher than the value indicated in the standard circuit example, the coil current may reverse when the load is light, and thus pulse skipping will not be possible and light load efficiency will worsen.
- 11) When the voltage difference between input voltage and output voltage is low, the load stability feature may deteriorate.
- 12) Soft-off function regenerates energy by Nch MOS switching Tr. Additionally the input voltage rises by the regenerative energy. In this case, please note the input voltage not to exceed 5.5V. The Lx voltage may be beyond the absolute maximum ratings when the input voltage exceeds 5.5V.

The rise of input voltage can be suppressed by increasing  $C_{IN}$ . Please increase  $C_{IN}$  based on the following equation. For your design, please evaluate this issue on your PCB and actual external components sufficiently.

[Equation]  $C_{IN}>(V_{OUT}-0.2)^2 \times C_L/(\Delta V_{IN} \times 2 \times V_{IN})$ 

 $\begin{array}{ll} V_{\text{IN}:} \text{ Input } \text{ voltage} \\ & \bigtriangleup V_{\text{IN}:} (5.5\text{-}V_{\text{IN}}) \\ & V_{\text{OUT}:} \text{ Output } \text{ voltage} \\ & C_{\text{L}:} \text{ Actual capacitance value of an output Capacitor (C_{\text{L}})} \\ & C_{\text{IN}:} \text{ Actual capacitance value of an input Capacitor (C_{\text{IN}})} \end{array}$ 

13) In case that the set output voltage is less than 0.8V with the PWM/PFM automatic control, super positioning ripple and efficiency decline can occur at the light load.

Due to this reason, please be sure to set the output voltage in the range of 0.8V to 3.6V for the PWM/PFM automatic control.

### ■NOTE ON USE (Continued)

14) Torex places an importance on improving our products and their reliability. We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

#### 15) Instructions of pattern layouts

The operation may become unstable due to noise and/or phase lag from the output current when the wire impedance is high, please place the input capacitor( $C_{IN}$ ) and the output capacitor ( $C_L$ ) as close to the IC as possible.

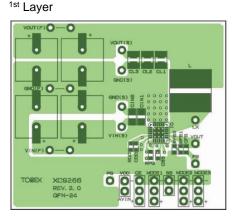
(1) In order to stabilize  $V_{IN}$  voltage level, we recommend that a by-pass capacitor ( $C_{IN}$ ,  $C_{DD}$ ) to be connected as close as possible to the  $PV_{IN}$  & PGND pins and the  $AV_{IN}$  & AGND pins.

(2) Please mount each external component as close to the IC as possible.

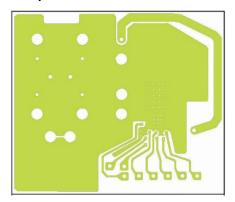
(3) Wire external components as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.

- (4) Make sure that the GND traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
- (5) This series' internal driver transistors bring on heat because of the output current and ON resistance of P-channel and N-channel MOS driver transistors. Please consider the countermeasures against heat if necessary.

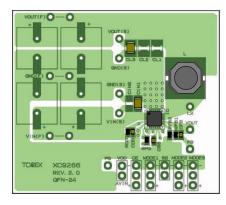
< Reference pattern layout >



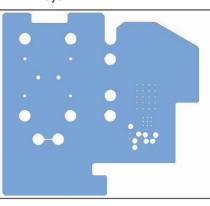
<sup>3rd</sup> Layer



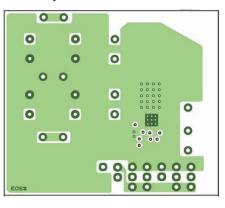
PCB mounted







4th Layer



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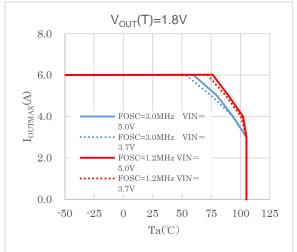
### ■NOTE ON USE (Continued)

<Estimation for the power consumption> The power loss of a total buck DC/DC system (P\_all) is as follows. P\_all =VIN×IIN-VOUT×IOUT =Vout×lout/EFFI-Vout×lout =-Vout×lout× (1-1/EFFI) The power loss at a coil (P\_coil) is as follows. P coil =  $I_{OUT}^2 \times DCR$ DCR: The direct current resistance of a coil The power loss at IC (P\_IC) can be calculated by subtracting the power loss at a coil from the one of a total buck DC/DC system.  $P_IC = P_all - P_coil$ The temperature of IC (Tj) can be calculated by the function below. R : Thermal resistance (°C/W)  $Tj = Ta + R \times P_IC$ The temperature resistance varies based on the power dissipation of a PC board and so on. Please note that Tj should be lower than 125°C <Calculation Example> ·Conditions : V<sub>IN</sub>=5.0V Vout=1.8V output current: IOUT=4.0A Efficiency: EFFI=87.8% Thermal resistance R=34.8°C/W (Mount on a board) DCR of a coil =5.81mΩ The power loss of a total buck DC/DC system (P\_all) =-VoutxIoutx (1-1/EFFI) =-1.8×4.0(1-1/0.878) ≒1.00 (W) The power loss at a coil (P\_coil) =  $I_{OUT}^2 \times DCR$ =4<sup>2</sup>×0.00581=0.093 (W) The power loss at IC (P\_IC) = P\_all - P\_coil =1.00 -0.093 =0.91 (W) The temperature of IC (Tj) = The ambient temperature so that Tj becomes125°C (Ta) =Tj-R×P\_IC =125-34.8×0.91 =93.3°C

In this case, under the condition above, the ambient temperature up to 93.3°C is acceptable

#### <Reference example>

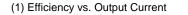
Ta-IOUTMAX feature example with QFN0404-24C recommendation PCB pattern

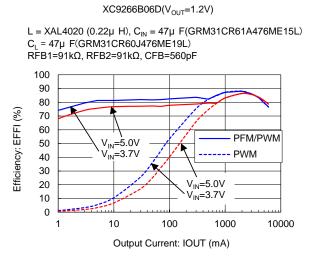


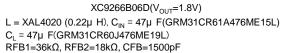
#### Measurement Condition

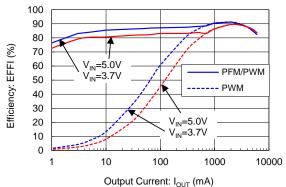
| Condition        | : Mount on a board                                                                                      |
|------------------|---------------------------------------------------------------------------------------------------------|
| Soldering        | : Lead (Pb) free                                                                                        |
| Board            | : Dimensions 53 x 54 mm (2862 mm <sup>2</sup> in one side)<br>(Reference pattern layout of QFN0404-24C) |
| Copper thickness | :18.35µm(Cu)+20µm(plating)=38.35µm                                                                      |
| Material         | : Glass Epoxy (FR-4)                                                                                    |
| Thickness        | :1.2mm                                                                                                  |
| Through-hole     | : 30×0.3 Diameter                                                                                       |
|                  | 8×0.8 Diameter                                                                                          |
|                  | 30×1.0 Diameter                                                                                         |
|                  |                                                                                                         |

### ■TYPICAL PERFORMANCE CHARACTERISTICS

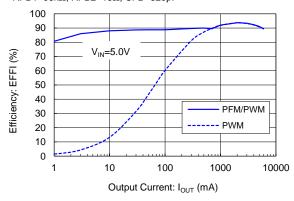


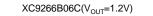




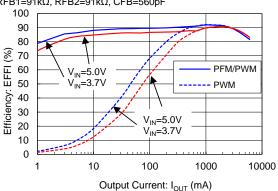


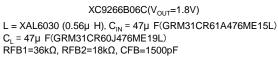
 $\label{eq:constraint} \begin{array}{l} XC9266B06D(V_{OUT}{=}3.3V) \\ L = XAL4020~(0.22\mu~H),~C_{IN} = 47\mu~F(GRM31CR61A476ME15L) \\ C_L = 94\mu~F(GRM31CR60J476ME19Lx2) \\ RFB1{=}68k\Omega,~RFB2{=}15\Omega,~CFB{=}820pF \end{array}$ 

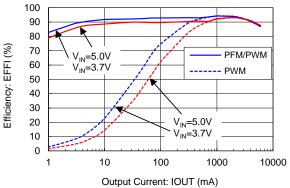




L = XAL6030 (0.56 $\mu$  H), C<sub>IN</sub> = 47 $\mu$  F(GRM31CR61A476ME15L) C<sub>L</sub> = 47 $\mu$  F(GRM31CR60J476ME19L) RFB1=91k $\Omega$ , RFB2=91k $\Omega$ , CFB=560pF

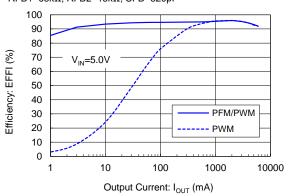




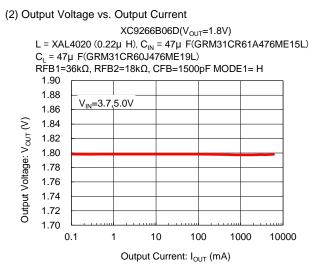


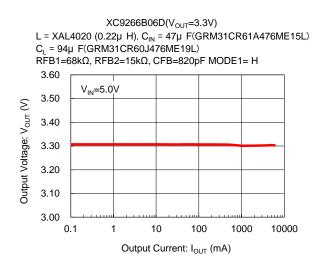
# $$\label{eq:constraint} \begin{split} & XC9266B06C(V_{OUT}{=}3.3V) \\ L = XAL6030 \; (0.56 \mu \ H), \ C_{IN} = 47 \mu \ F(GRM31CR61A476ME15L) \\ C_I = 94 \mu \ F(GRM31CR60J476ME19Lx2) \end{split}$$

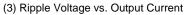
 $RFB1=68k\Omega$ ,  $RFB2=15k\Omega$ , CFB=820pF

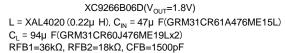


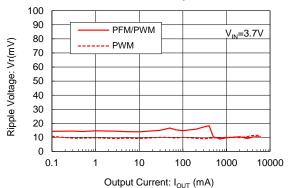
### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

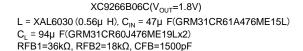


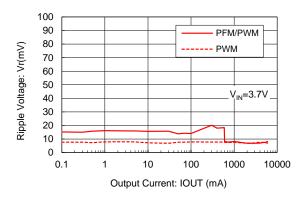


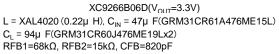


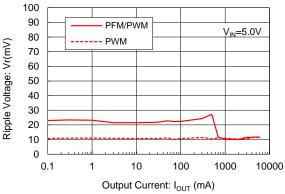




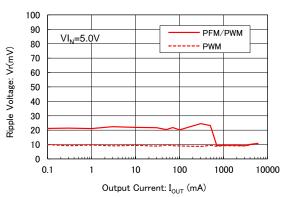






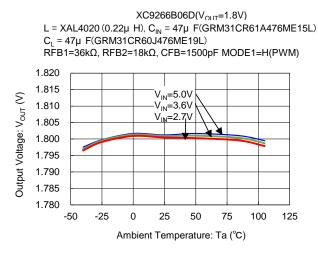


 $\label{eq:constraint} \begin{array}{l} XC9266B06C(V_{OUT}{=}3.3V) \\ L = XAL6030~(0.56\mu~H),~C_{IN} = 47\mu~F(GRM31CR61A476ME15L) \\ C_{L} = 94\mu~F(GRM31CR60J476ME19Lx2) \\ RFB1{=}68k\Omega,~RFB2{=}15k\Omega,~CFB{=}820pF \end{array}$ 



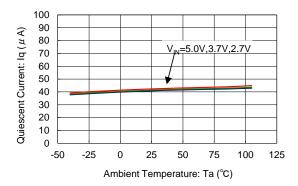
### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

#### (4) Output Voltage vs. Ambient Temperature

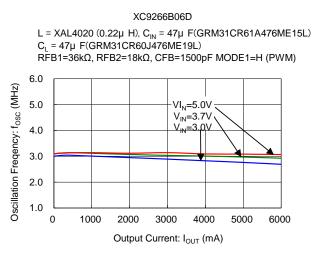


#### (6) Quiescent Current vs. Ambient Temperature

#### XC9266B06D

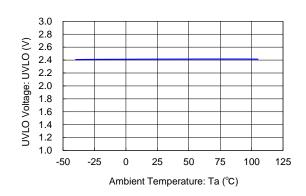


(8) Oscillation Frequency vs. Ambient Temperature



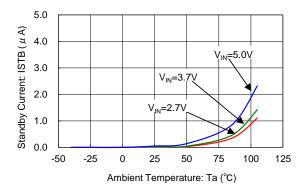
(5) UVLO Voltage vs. Ambient Temperature

XC9266B06D

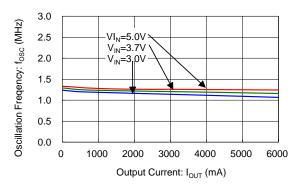


#### (7) Stand-by Current vs. Ambient Temperature

XC9266B06D

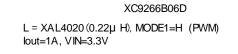


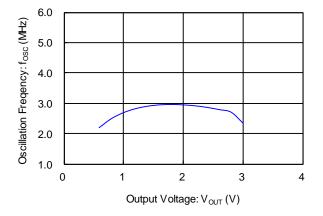
 $\label{eq:constraint} \begin{array}{l} XC9266B06C\\ L = XAL6030 \ (0.56 \mu \ H), \ C_{IN} = 47 \mu \ F(GRM31CR61A476ME15L)\\ C_{L} = 47 \mu \ F(GRM31CR60J476ME19L)\\ RFB1=36 k\Omega, \ RFB2=18 k\Omega, \ CFB=1500 pF \ MODE1=H \ (PWM) \end{array}$ 



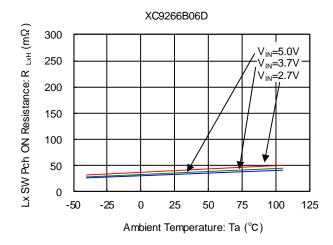
### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

#### (9) Oscillation Frequency vs. Output Voltage

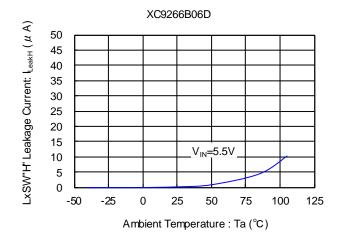


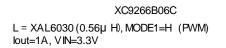


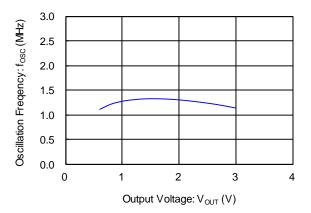
#### (10) Pch Driver ON Resistance vs. Ambient Temperature

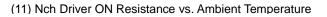


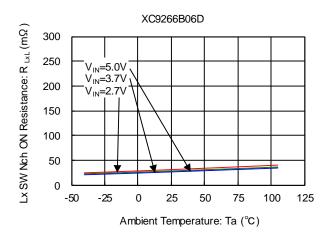
(12) LxSW"H" Leakage Current vs. Ambient Temperature



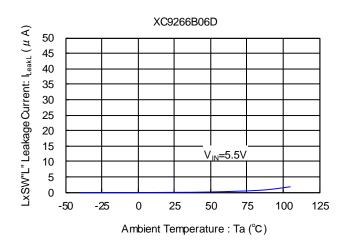








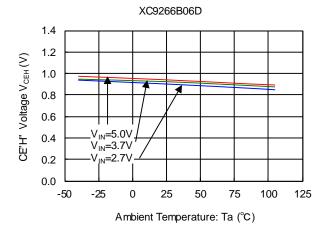
(13) LxSW"L" Leakage Current vs. Ambient Temperature



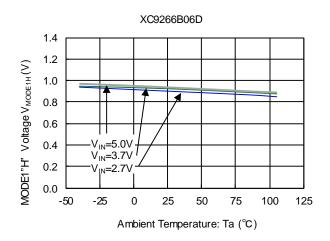
### ■TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(14) CE"H" Voltage vs. Ambient Temperature

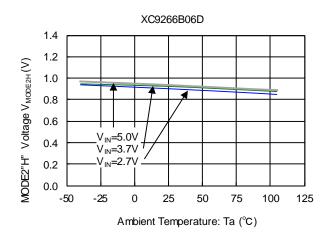
(15) CE"L" Voltage vs. Ambient Temperature

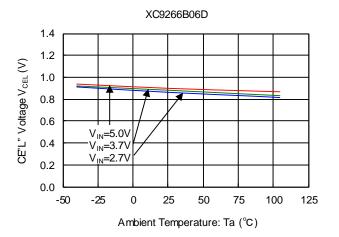


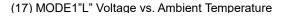
#### (16) MDOE1"H" Voltage vs. Ambient Temperature

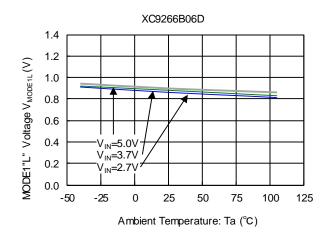


(18) MDOE2"H" Voltage vs. Ambient Temperature

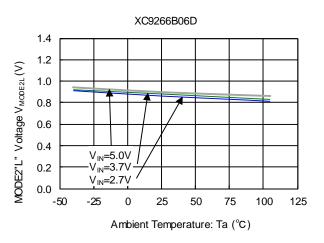








(19) MODE2"L" Voltage vs. Ambient Temperature

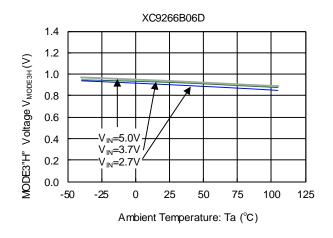


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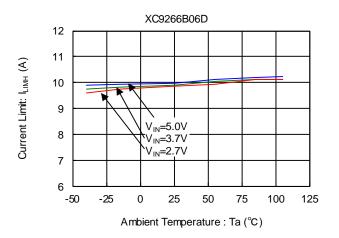
### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(20) MDOE3"H" Voltage vs. Ambient Temperature

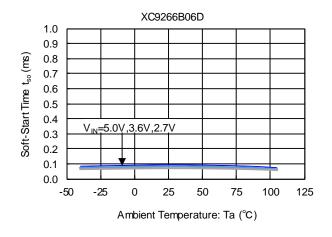
(21) MODE3"L" Voltage vs. Ambient Temperature

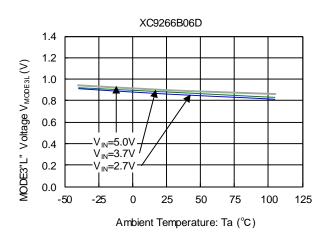


(22) Current Limit vs. Ambient Temperature

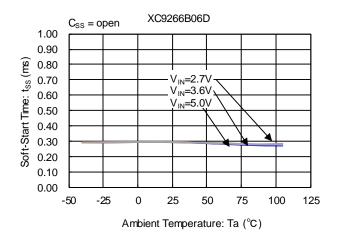


(24) Soft - off Time vs. Ambient Temperature

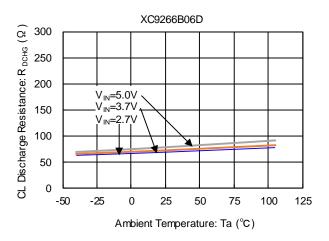




(23)Soft-Start Time vs. Ambient Temperature



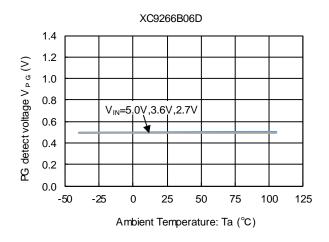
(25) CL Discharge Resistance vs. Ambient Temperature

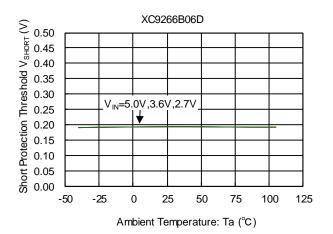


### ■ TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(26) PG detect voltage vs. Ambient Temperature

(27) Short Protection Threshold vs. Ambient Temperature

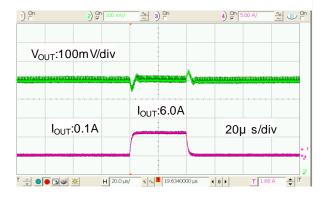




### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(28) Load Transient Response

 $\begin{array}{l} XC9266B06D \\ V_{\text{IN}} = 5.0V \; V_{\text{OUT}} = 1.2V \; f_{\text{OSC}} = 3.0 \text{MHz} \; I_{\text{OUT}} = 0.1 \text{A} \Rightarrow 6.0 \text{A} \\ \text{L} = XAL4020 \; (0.22 \mu \; \text{H}), \; \text{C}_{\text{IN}} = 47 \mu \; \text{F}(\text{GRM31CR61A476ME15L}) \\ \text{C}_{\text{L}} = 47 \mu \; \text{F}(\text{GRM31CR60J476ME19L}) \\ \text{RFB1=91k}\Omega, \; \text{RFB2=91k}\Omega, \; \text{CFB=560pF} \; \text{MODE1=H} \; (\text{PWM}) \end{array}$ 

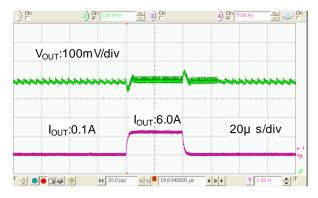


XC9266B06D V<sub>IN</sub>=5.0V V<sub>OUT</sub> = 1.8V f<sub>OSC</sub> = 3.0MHz l<sub>OUT</sub> = 0.1A ⇒ 6.0A L = XAL4020 (0.22µ H), C<sub>IN</sub> = 47µ F(GRM31CR61A476ME15L) C<sub>L</sub> = 47µ F(GRM31CR60J476ME19L) RFB1=36kΩ, RFB2=18kΩ, CFB=1500pF MODE1=H (PWM)

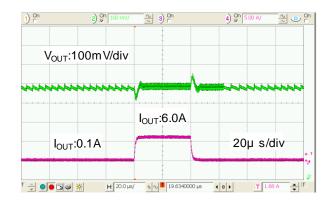


XC9266B06D  $V_{IN}$  = 5.0V  $V_{OUT}$  = 3.3V  $f_{OSC}$  = 3.0MHz  $I_{OUT}$  = 0.1A ⇒ 6.0A L = XAL4020 (0.22µH),  $C_{IN}$  = 47µF(GRM31CR61A476ME15L)  $C_L$ = 94µF(GRM31CR60J476ME19Lx2) RFB1=68kΩ, RFB2=15kΩ, CFB=820pF MODE1=H (PWM)

) P<sup>n</sup> 2) P<sup>n</sup> 100 mV/ 2 3) P<sup>n</sup> 4) P<sup>n</sup> 500 A/ 2 0 P<sup>n</sup> V<sub>OUT</sub>:100m V/div I<sub>OUT</sub>:6.0A I<sub>OUT</sub>:6.0A 20μ s/div  $\begin{array}{l} XC9266B06D \\ V_{\text{IN}}{=}\,5.0V\,V_{\text{OUT}}{=}\,1.2V\,f_{\text{OSC}}{=}\,3.0\text{MHz}\,I_{\text{OUT}}{=}\,0.1A\Rightarrow 6.0A \\ L {=}\,XAL4020\,(0.22\mu\,\text{H}),\,C_{\text{IN}}{=}\,47\mu\,\,F(\text{GRM31CR61A476ME15L}) \\ C_{\text{L}}{=}\,47\mu\,\,F(\text{GRM31CR60J476ME19L}) \\ \text{RFB1}{=}91k\Omega,\,\,\text{RFB2}{=}91k\Omega,\,\,\text{CFB}{=}560\text{pF}\,\,\text{MODE1}{=}\text{L}\,\,(\text{PFMPWM}) \end{array}$ 



$$\begin{split} & \text{XC9266B06D} \\ V_{\text{IN}} = 5.0V \; V_{\text{OUT}} = 1.8V \; f_{\text{OSC}} = 3.0\text{MHz} \; l_{\text{OUT}} = 0.1\text{A} \Rightarrow 6.0\text{A} \\ L = \text{XAL4020} \; (0.22\mu \; \text{H}), \; C_{\text{IN}} = 47\mu \; \text{F}(\text{GRM31CR61A476ME15L}) \\ C_{\text{L}} = 47\mu \; \text{F}(\text{GRM31CR60J476ME19L}) \\ \text{RFB1=36k}\Omega, \; \text{RFB2=18k}\Omega, \; \text{CFB=1500pF} \; \text{MODE1=L} \; (\text{PFWPWM}) \end{split}$$



#### XC9266B06D $V_{IN}$ = 5.0V $V_{OUT}$ = 3.3V $f_{OSC}$ = 3.0MHz $I_{OUT}$ = 0.1A ⇒ 6.0A L = XAL4020 (0.22µH), $C_{IN}$ = 47µF(GRM31CR61A476ME15L) CL = 94µF(GRM31CR60J476ME19Lx2)

RFB1=68k $\Omega$ , RFB2=15k $\Omega$ , CFB=820pF MODE1=L (PFM/PWM)



### TYPICAL PERFORMANCE CHARACTERISTICS(Continued)

(28) Load Transient Response



I<sub>OUT</sub>:0.1A I<sub>OUT</sub>:6.0A 20μ s/div 1 275A Φ<sup>T</sup>

XC9266B06C  $V_{IN} = 5.0V V_{OUT} = 1.8V f_{OSC} = 1.2MHz I_{OUT} = 0.1A \Rightarrow 6.0A$ L = XAL6030 (0.56µH), C<sub>IN</sub> = 47µF(GRM31CR61A476ME15L) C<sub>L</sub> = 47µF(GRM31CR60J476ME19L) RFB1=36kQ, RFB2=18kQ, CFB=1500pF MODE1=H (PWM)





 $\begin{array}{l} XC9266B06C \\ V_{\text{IN}}{=}5.0V \; V_{\text{OUT}}{=}\;1.2V \; f_{\text{OSC}}{=}\;1.2M\text{Hz} \; l_{\text{OUT}}{=}\;0.1A \Rightarrow 6.0A \\ L {=}\;XAL6030 \; (0.56\mu\text{H}), \; C_{\text{IN}}{=}\;47\mu \; \text{F}(\text{GRM31CR61A476ME15L}) \\ C_{\text{L}}{=}\;47\mu \; \text{F}(\text{GRM31CR60J476ME19L}) \\ \text{RFB1}{=}91\text{k}\Omega, \; \text{RFB2}{=}91\text{k}\Omega, \; \text{CFB}{=}560\text{pF} \; \text{MODE1}{=}\text{L} \; (\text{PFWPWM}) \end{array}$ 



XC9266B06C  $V_{IN}$  = 5.0V  $V_{OUT}$  = 1.8V  $f_{OSC}$  = 1.2MHz  $I_{OUT}$  = 0.1A ⇒ 6.0A L = XAL6030 (0.56µH),  $C_{IN}$  = 47µ F(GRM31CR61A476ME15L)  $C_{L}$  = 47µ F(GRM31CR60J476ME19L) RFB1=36kΩ, RFB2=18kΩ, CFB=1500pF MODE1=L (PFWPWM)



 $\begin{array}{l} XC9266B06C \\ V_{\text{IN}} = 5.0V \; V_{\text{OUT}} = 3.3V \; f_{\text{OSC}} = 1.2 \text{MHz} \; l_{\text{OUT}} = 0.1 \text{A} \Rightarrow 6.0 \text{A} \\ L = XAL6030 \; (0.56 \mu\text{H}), \; C_{\text{IN}} = 47 \mu\text{F}(\text{GRM31CR61A476ME15L}) \\ C_{\text{L}} = 94 \mu\text{F}(\text{GRM31CR60J476ME19Lx2}) \\ \text{RFB1=68k}\Omega, \; \text{RFB2=15k}\Omega, \; \text{CFB=820pF} \; \text{MODE1=L} \; (\text{PFM/PWM}) \end{array}$ 



### ■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

| PACKAGE     | OUTLINE / LAND PATTERN | THERMAL CHARACTERISTICS |                               |
|-------------|------------------------|-------------------------|-------------------------------|
| QFN0404-24C | QFN0404-24C PKG        | Standard Board          | QFN0404-24C Power Dissipation |

### ■MARKING RULE

#### ① represents product series

| MARK | PRODUCT SERIES |
|------|----------------|
| 6    | XC9266*****-G  |

2 represents Type and Adjustable Output Voltage

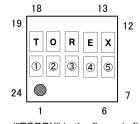
| MARK | PRODUCT SERIES |
|------|----------------|
| В    | XC9266B06***-G |

③ represents Oscillation Frequency

| MARK | frequency | PRODUCT SERIES |
|------|-----------|----------------|
| С    | 1.2MHz    | XC9266***C**-G |
| D    | 3.0MHz    | XC9266***D**-G |

(④),(⑤) represents production lot number
 01~09、0A~0Z、11~9Z、A1~A9、AA~AZ、B1~ZZ in order.
 (G, I, J, O, Q, W excluded)
 \* No character inversion used.

#### QFN0404-24C



("TOREX" in the figure is fixed)

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